These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

ZZ2
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.
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